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PAPER NUMBER

APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/684,898	10/10/2000	Yosuke Shirata	980511B	2212	
7	590 03/19/2002				
ARMSTRONG, WESTERMAN, HATTORI		EXAMINER			
McLELAND & NAUGHTON Suite 1000			NGUYEN, HUNG		
1725 K Street,	N. W.				

2851
DATE MAILED: 03/19/2002

Please find below and/or attached an Office communication concerning this application or proceeding.

	Application No.	Applicant(s)			
	09/684,898	SHIRATA, YOSUKE			
	Examiner	Art Unit			
	Henry Hung V Nguyen	2851			
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N.	IS SET TO EXPIRE 3 MONTH(
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This	s action is non-final.				
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riority documents have been received in this National Stage Bureau (PCT Rule 17.2(a)). ist of the certified copies not received.					
estic priority under 35 U.S.C. § 119(e) (to a provisional application).					
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Office Action Summary

-- Th MAILING DATE of this communication

Period for Reply

A SHORTENED STATUTORY PERIOD FOR RE THE MAILING DATE OF THIS COMMUNICATION

Extensions of time may be available under the provisions of 37 CF after SIX (6) MONTHS from the mailing date of this communication

2b)⊠

- If the period for reply specified above is less than thirty (30) days, a
- If NO period for reply is specified above, the maximum statutory pe
- Failure to reply within the set or extended period for reply will, by st
 Any reply received by the Office later than three months after the m
- earned patent term adjustment. See 37 CFR 1.704(b).

This action is FINAL

Status				
1)🖂	Responsive to communication(s) filed on 10 October 2000.			

3) Since this application is in condition for all closed in accordance with the practice un

Dis

2a) □

Αp

position of Claims
4) Claim(s) 1-8,10-15,17 and 19-29 is/are pending in the application.
4a) Of the above claim(s) is/are withdrawn from consideration.
5) Claim(s) is/are allowed.
6) Claim(s) <u>1-8,10-15,17 and 19-29</u> is/are rejected.
7) Claim(s) is/are objected to.
8) Claim(s) are subject to restriction and/or election requirement.
plication Papers
9) The specification is objected to by the Examiner.
0) The drawing(s) filed on is/are: a) accepted or b) objected to by the Example 1
Applicant may not request that any objection to the drawing(s) he held in abeyance. So

12) The oath or declaration is objected to by the Priority under 35 U.S.C. §§ 119 and 120

13) Acknowledgment is made of a claim for fore

a)

All b)

Some * c)

None of:

11) The proposed drawing correction filed on If approved, corrected drawings are required in

1. Certified copies of the priority docume

2. Certified copies of the priority docum

3. Copies of the certified copies of the p application from the International

* See the attached detailed Office action for a

14) Acknowledgment is made of a claim for dome a) The translation of the foreign language

15) Acknowledgment is made of a claim for domestic priority under 35 U.S.C. §§ 120 and/or 121.

Attachment(s)

1)	M	Notice of	References	Citod	DTO BOOK

2) Notice of Draftsperson's Patent Drawing Review (PTO-948)

3) Information Disclosure Statement(s) (PTO-1449) Paper No(s) 3.

4) 🔲 Interview Summary (PTO-413) Paper No(s). 5) Notice of Informal Patent Application (PTO-152) 6) Other:

DETAILED ACTION

Claim Rejections - 35 USC § 102

 The following is a quotation of the appropriate paragraphs of 35 U.S.C. 102 that form the basis for the rejections under this section made in this Office action:

A person shall be entitled to a patent unless -

(e) the invention was described in a patent granted on an application for patent by another filed in the United States before the invention thereof by the applicant for patent, or on an international application by another who has fulfilled the requirements of paragraphs (1), (2), and (4) of section 371(c) of this title before the invention thereof by the applicant for patent.

The changes made to 35 U.S.C. 102(e) by the American Inventors Protection Act of 1999 (AIPA) do not apply to the examination of this application as the application being examined was not (1) filed on or after November 29, 2000, or (2) voluntarily published under 35 U.S.C. 122(b). Therefore, this application is examined under 35 U.S.C. 102(e) prior to the amendment by the AIPA (pre-AIPA 35 U.S.C. 102(e)).

 Claims 5-6, 8-13, 15-17, 19-28 are rejected under 35 U.S.C. 102(e) as being clearly anticipated by Semba (U.S.Pat. 6,133,981).

With regard to claims 5-6, 8-13, 15-17, 19-28, Semba discloses a processing system comprising all of the structures set forth in the instant claims such as: an exposure system (S) for exposing a substrate and which is connected to coating/developing system (1) for processing the substrate before or after exposure (see fig. 1); a sensor (101) for obtaining the environmental condition of the processing chamber (1) and a sensor (102) for obtaining the environmental condition of the exposure chamber (S) and a control system (104) for controlling at least the environment of the exposure chamber in accordance with data obtained from the processing chamber (see col.6, lines 18-27).

With respect to the intervening effective filing date of Semba, applicants' attention is directed to the procedure set forth in MPEP section 201.15.

Claim Rejections - 35 USC § 103

- The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all
 obviousness rejections set forth in this Office action:
 - (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

Claims 1-8, 10-15, 17, 19-29 are rejected under 35 U.S.C. 103(a) as being unpatentable over Umatate et al (U.S.Pat. 5,243,377).

With regard to claims 1-8, 10-15, 17, 19-29, Umatate et la (fig.1) discloses a lithography system comprising a plurality of exposure apparatus (EXP1 to EXPn) for transferring a pattern formed on a mask onto a substrate wherein each of which is different from each other; and a plurality of substrate process apparatuses for processing the substrate; where the plurality exposure apparatuses and the substrate processing apparatuses (coater developers) are used in parallel manner (see col.1, lines 20-40); measuring devices for measuring specific information in each of the exposure apparatus and variable according to operating conditions of each of the exposure apparatus and coater developer apparatus (see abstract and col.2, lines 35-39; and lines). Umatate et al does not expressly disclose the environment of the exposure apparatus being adjusted the same as the environment in the substrate processing apparatus based in "an environment sensor". However, Umatate et al does teach the lithography system further having an information gathering apparatus for gathering the measured specific information; and a system observer apparatus and a host computer (H-com) controls, modifies and corrects working

parameters each of the exposure apparatus and processing apparatus based on the gathering information. In view of such teachings, it would have been obvious to one having ordinary skill in the art to modify the teachings of Umatate to obtain the invention as specified in claims of the instant invention. It would have been obvious to a skilled artisan to adjust the environmental condition (such as temperature, humidity or pressure) of the exposure apparatus the same as the environmental condition of the substrate processing apparatus "in such a manner that the operating conditions can be stably maintained" as suggested by Umatate.

2/11/03

4. Claims 1-8, 10-15, 17 and 19-29 are rejected under 35 U.S.C. 103(a) as being 5,828,572と unpatentable over Hasegawa et al (U.S.Pat. 5,871, 587) in view of Umatate et al (U.S.Pat. 5,243,377).

With regard to claims 1-8, 10-15, 17 and 19-29, Hasegawa discloses a processing system and semiconductor production method which includes all of the claimed subject matter in the above claims. Hasegawa teaches a lithography method and apparatus including the following (see Figure 1, and page 2, line 32-page 3 line 22): an exposure apparatus (3), a substrate processing apparatus (4), environment sensors which measure temperature (9a-c), environment control devices (7a-e, 8a-e), wherein (see Figure 3):

- a. the substrate processing apparatus is a coater, which coats the substrate before exposure, and a developer, which develops the substrate after exposure, (page 2 lines 45-48).
- b. the data measured by the sensors is temperature, (page 3 lines 6-11),
- the environment controllers are guided by the data gathered from the sensors, (page 3 lines 14-22),

- the exposure apparatus and substrate processing apparatus are separately housed,
 (Figure 1)
- d. the exposure apparatus and substrate processing apparatus are an in-line system,
 (Figure 1),
- e. the environment of the exposure apparatus and the [substrate] processing apparatus are controlled to be substantially the same.

Regarding Claims 20 and 23, the claimed method of making the above exposure and substrate processing apparatuses is inherent in the existence of the apparatuses, that is, in the construction of Hasegawa's apparatus, necessarily an adjusting device (7a-e) and a controlling device (11) were provided.

Regarding Claim 26, see page 3, lines 57-63. The monitor 11 monitors the conditions in the processing chambers and adjusts the environment of the processing chambers accordingly.

Regarding Claims 27 and 28, see figure 1. The system of Hasegawa teaches:

- a. a chamber (2) disposed around the exposure body system (3),
- b. a chamber (2) disposed around the substrate processing apparatus (4).
- b. an adjusting device (7a-e) connected to said chamber.
- c. a control device (8a-e) which controls the environment in the chamber depending on the environment of the substrate processing apparatus or the exposure apparatus.

Hasegawa et al does not expressly teach "an environmental sensor provided in at least one of the first and the second chambers which measures an environment in said at least one of the first and second chamber". However, Hasegawa teaches "monitoring the operating state of the exposure chamber 3 (see col.3, lines 16-18); and "monitors the processing parameters of each processing parameters of each processing chamber (see col.3, line 57-59). This provides a clear

suggestion that it would have been obvious to one having ordinary skill in the art at the time the

invention was made to place at least "a sensor" in the exposure apparatus chamber and substrate

processing chamber for monitoring at least the environment conditions of these chambers. The

purpose of doing so would have been to at least maintain a same cleanliness environment

condition for both exposure apparatus chamber and substrate processing chamber.

Response to Amendment

5 Applicant's amendment filed December 21, 2000 have been entered. Claims 9, 16, 18

are cancelled. Claims 1, 2, 5, 7, 12-1520, 23, 26-28 are amended. With respect to prior art

rejection, applicant's arguments have been carefully considered but have been traversed in view

of new ground rejections as set forth above.

Any inquiry concerning this communication or earlier communications from the

examiner should be directed to Henry Hung V Nguyen whose telephone number is 703-305-

6462. The examiner can normally be reached on Monday-Friday (First Friday off).

If attempts to reach the examiner by telephone are unsuccessful, the examiner's

supervisor, Russ Adams can be reached on 703-308-2847.

Any inquiry of a general nature or relating to the status of this application or proceeding

should be directed to the receptionist whose telephone number is 703-305-4900.

hvn

March 14, 2002